

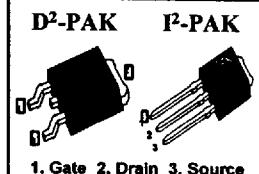
Advanced Power MOSFET

IRLW/IZ34A

FEATURES

- Avalanche Rugged Technology
- Rugged Gate Oxide Technology
- Lower Input Capacitance
- Improved Gate Charge
- Extended Safe Operating Area
- 175° • Operating Temperature
- Lower Leakage Current : 10 μ A (Max.) @ $V_{DS} = 60V$
- Lower $R_{DS(on)}$: 0.033 Ω (Typ.)

$BV_{DSS} = 16 V$
 $R_{DS(on)} = 0.046 \Omega$
 $I_D = 30 A$



Absolute Maximum Ratings

Symbol	Characteristic	Value	Units
V_{DSS}	Drain-to-Source Voltage	60	V
I_D	Continuous Drain Current ($T_c=25^\circ C$)	30	A
	Continuous Drain Current ($T_c=100^\circ C$)	21	
I_{DM}	Drain Current-Pulsed	105	A
V_{GS}	Gate-to-Source Voltage	± 20	V
E_{AS}	Single Pulsed Avalanche Energy	463	mJ
I_{AR}	Avalanche Current	30	A
E_{AR}	Repetitive Avalanche Energy	8.3	mJ
dv/dt	Peak Diode Recovery dv/dt	5.5	V/ns
P_D	Total Power Dissipation ($T_A=25^\circ C$)*	3.8	W
	Total Power Dissipation ($T_c=25^\circ C$)	83	W
	Linear Derating Factor	0.55	W/ $^\circ C$
T_J, T_{STG}	Operating Junction and Storage Temperature Range	-55 to +175	$^\circ C$
T_L	Maximum Lead Temp. for Soldering Purposes, 1/8" from case for 5-seconds	300	

Thermal Resistance

Symbol	Characteristic	Typ.	Max.	Units
$R_{\theta JC}$	Junction-to-Case	--	1.81	$^\circ C/W$
$R_{\theta JA}$	Junction-to-Ambient *	--	40	
$R_{\theta JA}$	Junction-to-Ambient	--	62.5	

* When mounted on the minimum pad size recommended (PCB Mount).



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Electrical Characteristics ($T_C=25^\circ\text{C}$ unless otherwise specified)

Symbol	Characteristic	Min.	Typ.	Max.	Units	Test Condition
BV_{DSS}	Drain-Source Breakdown Voltage	60	—	—	V	$\text{V}_{\text{GS}}=0\text{V}, \text{I}_D=250\text{ }\mu\text{A}$
$\Delta\text{BV}/\Delta T_J$	Breakdown Voltage Temp. Coeff.	—	0.06	—	$\text{V}/^\circ\text{C}$	$\text{I}_D=250\text{ }\mu\text{A}$ See Fig 7
$\text{V}_{\text{GS(th)}}$	Gate Threshold Voltage	1.0	—	2.0	V	$\text{V}_{\text{DS}}=5\text{V}, \text{I}_D=250\text{ }\mu\text{A}$
I_{GSS}	Gate-Source Leakage , Forward	—	—	100	nA	$\text{V}_{\text{GS}}=20\text{V}$
	Gate-Source Leakage , Reverse	—	—	-100		$\text{V}_{\text{GS}}=-20\text{V}$
I_{DSS}	Drain-to-Source Leakage Current	—	—	10	μA	$\text{V}_{\text{DS}}=60\text{V}$
		—	—	100		$\text{V}_{\text{DS}}=48\text{V}, \text{T}_C=150^\circ\text{C}$
$\text{R}_{\text{DS(on)}}$	Static Drain-Source On-State Resistance	—	—	0.046	Ω	$\text{V}_{\text{GS}}=5\text{V}, \text{I}_D=15\text{A}$ ④
g_{fs}	Forward Transconductance	—	19	—	S	$\text{V}_{\text{DS}}=30\text{V}, \text{I}_D=15\text{A}$ ④
C_{iss}	Input Capacitance	—	970	1260	pF	$\text{V}_{\text{GS}}=0\text{V}, \text{V}_{\text{DS}}=25\text{V}, f=1\text{MHz}$ See Fig 5
C_{oss}	Output Capacitance	—	334	385		
C_{rss}	Reverse Transfer Capacitance	—	131	150		
$t_{\text{d(on)}}$	Turn-On Delay Time	—	13	35	ns	$\text{V}_{\text{DD}}=30\text{V}, \text{I}_D=30\text{A}, \text{R}_G=6\Omega$ See Fig 13 ④ ⑤
t_r	Rise Time	—	21	55		
$t_{\text{d(off)}}$	Turn-Off Delay Time	—	36	80		
t_f	Fall Time	—	28	65		
Q_g	Total Gate Charge	—	27	35	nC	$\text{V}_{\text{DS}}=48\text{V}, \text{V}_{\text{GS}}=5\text{V}, \text{I}_D=30\text{A}$ See Fig 6 & Fig 12 ④ ⑤
Q_{gs}	Gate-Source Charge	—	9	—		
Q_{gd}	Gate-Drain("Miller") Charge	—	12	—		

Source-Drain Diode Ratings and Characteristics

Symbol	Characteristic	Min.	Typ.	Max.	Units	Test Condition
I_s	Continuous Source Current	—	—	30	A	Integral reverse pn-diode in the MOSFET
I_{SM}	Pulsed-Source Current ①	—	—	105		
V_{SD}	Diode Forward Voltage ④	—	—	1.6	V	$\text{T}_J=25^\circ\text{C}, \text{I}_s=30\text{A}, \text{V}_{\text{GS}}=0\text{V}$
t_{rr}	Reverse Recovery Time	—	64	—		
Q_{rr}	Reverse Recovery Charge	—	0.122	—	μC	$d\text{i}_f/dt=100\text{A}/\mu\text{s}$ ④

Notes :

- ① Repetitive Rating : Pulse Width Limited by Maximum Junction Temperature
- ② $L=0.6\text{mH}, \text{I}_{AS}=30\text{A}, \text{V}_{DD}=25\text{V}, \text{R}_G=27\Omega$, Starting $\text{T}_J=25^\circ\text{C}$
- ③ $\text{I}_{SD} \leq 30\text{A}, d\text{i}/dt \leq 300\text{A}/\mu\text{s}, \text{V}_{DD} \leq \text{BV}_{DSS}$, Starting $\text{T}_J=25^\circ\text{C}$
- ④ Pulse Test : Pulse Width = 250 μs , Duty Cycle $\leq 2\%$
- ⑤ Essentially Independent of Operating Temperature

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Fig 1. Output Characteristics

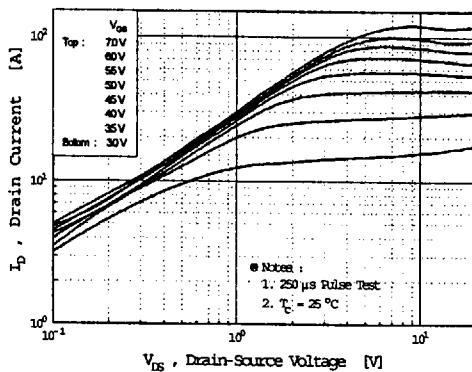


Fig 2. Transfer Characteristics

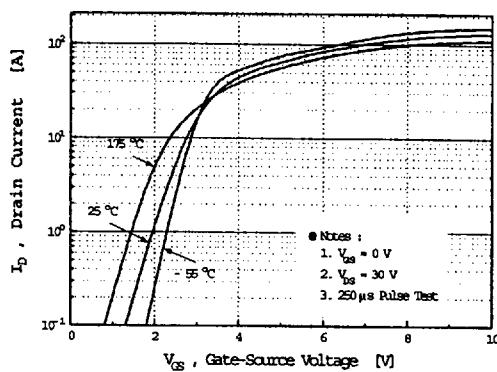


Fig 3. On-Resistance vs. Drain Current

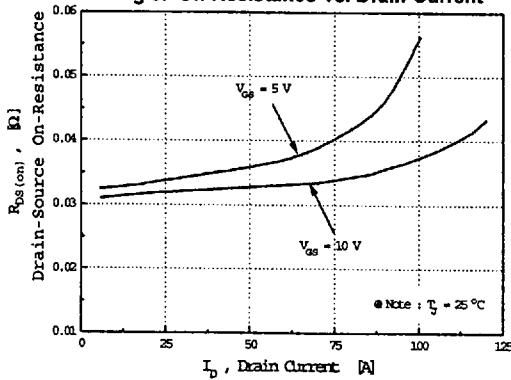


Fig 4. Source-Drain Diode Forward Voltage

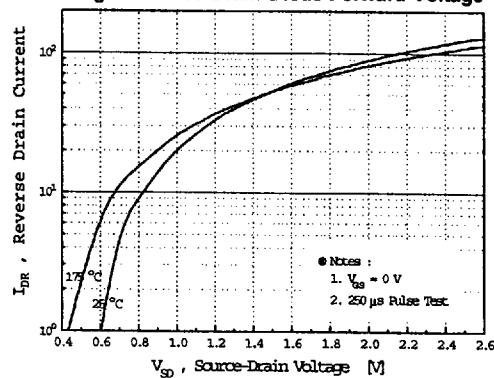


Fig 5. Capacitance vs. Drain-Source Voltage

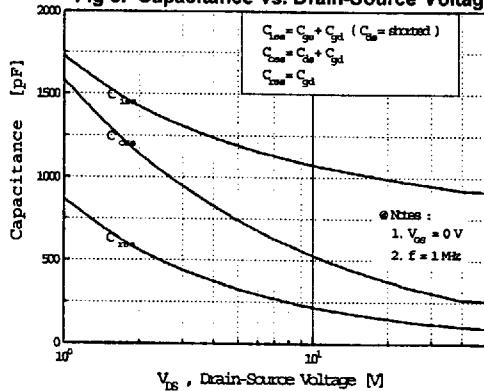
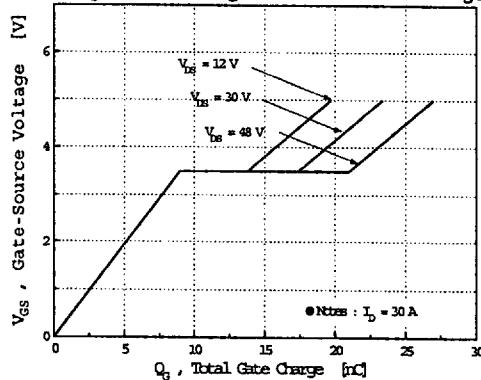
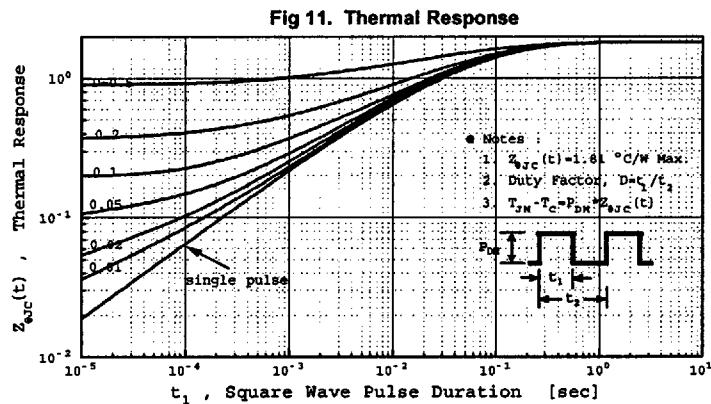
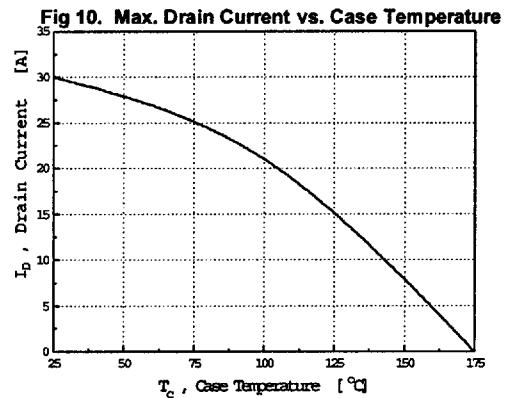
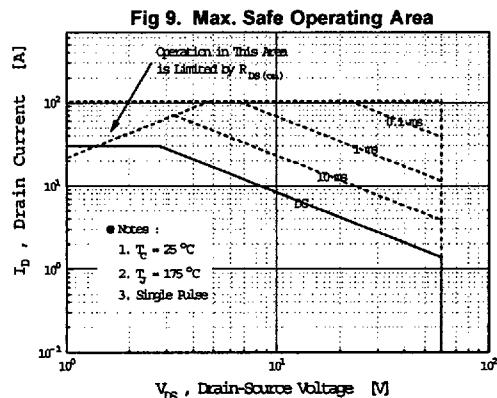
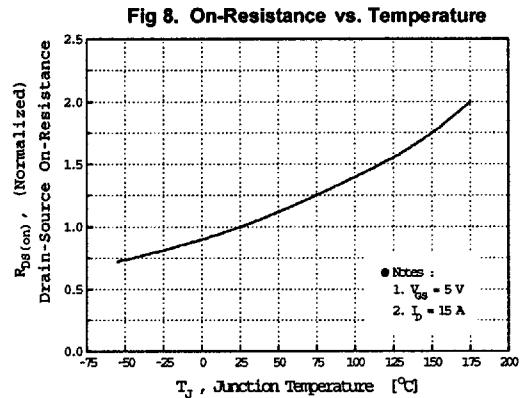
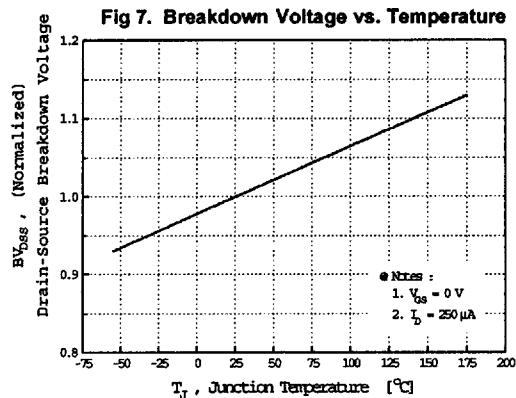


Fig 6. Gate Charge vs. Gate-Source Voltage



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Fig 12. Gate Charge Test Circuit & Waveform

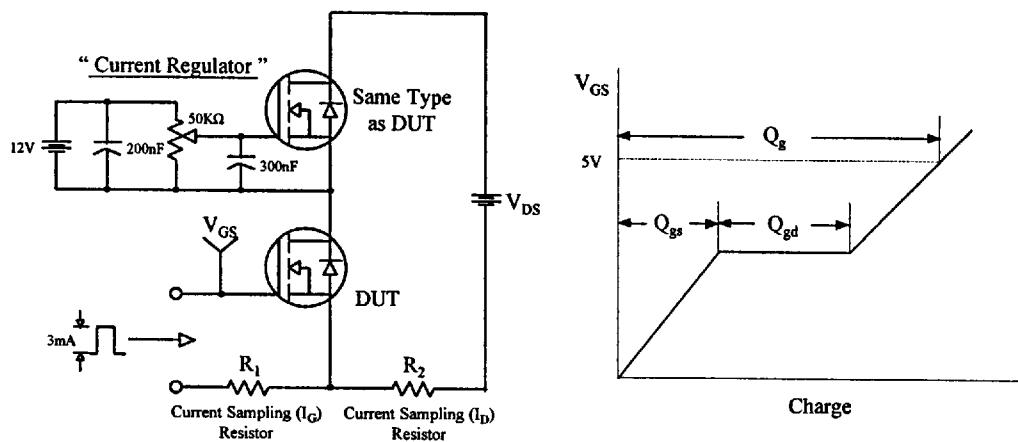


Fig 13. Resistive Switching Test Circuit & Waveforms

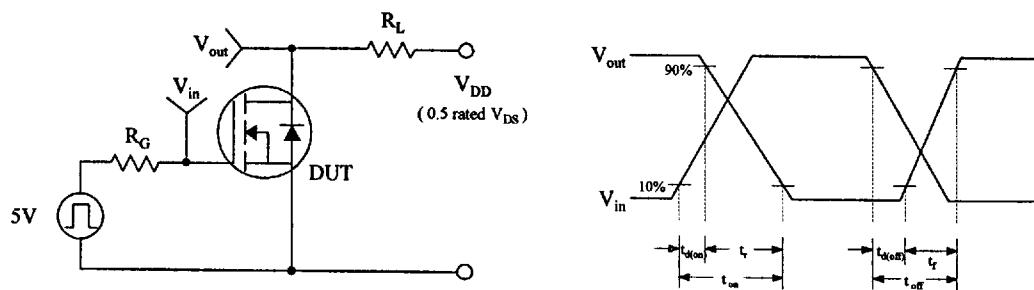
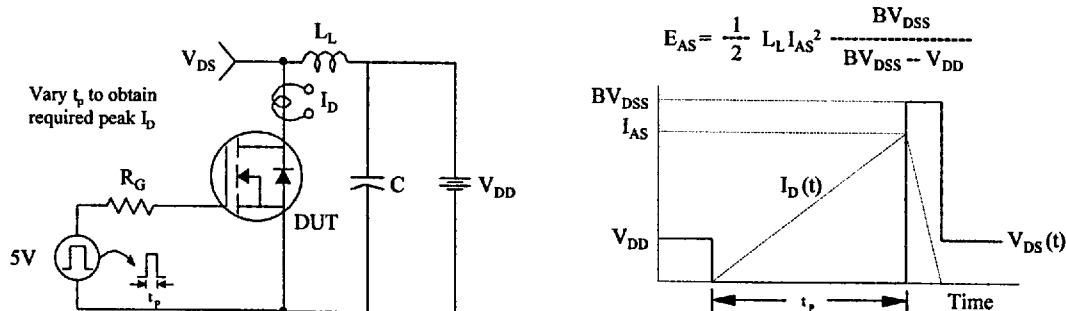


Fig 14. Unclamped Inductive Switching Test Circuit & Waveforms



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Fig 15. Peak Diode Recovery dv/dt Test Circuit & Waveforms

